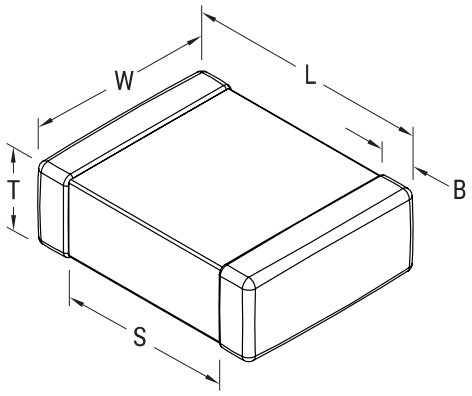
# KEMET Part Number: C0805X470J5GACTU

(C0805X470J5GAC7800)

SMD Comm C0G Flex, Ceramic, 47 pF, 5%, 50 VDC, C0G, SMD, MLCC, FT-CAP, Ultra-Stable, 0805




| General Information | |
|---|---|
| **Series:** | SMD Comm C0G Flex |
| **Style:** | SMD Chip |
| **Description:** | SMD, MLCC, FT-CAP, Ultra-Stable |
| **Features:** | FT-CAP, Ultra-Stable |
| **RoHS:** | Yes |
| **Termination:** | Flexible Termination |
| **Marking:** | No |
| **AEC-Q200:** | No |
| **Component Weight:** | 11 mg |
| **Shelf Life:** | 78 Weeks |
| **MSL:** | 1 |

| Dimensions | |
|---|---|
| **Chip Size** | 0805 |
| **L** | 2mm +/-0.3mm |
| **W** | 1.25mm +/-0.3mm |
| **T** | 0.78mm +/-0.20mm |
| **S** | 0.75mm MIN |
| **B** | 0.5mm +/-0.25mm |

| Specifications | |
|---|---|
| **Capacitance:** | 47 pF |
| **Measurement Condition:** | 1 MHz 1.0Vrms |
| **Capacitance Tolerance:** | 5% |
| **Voltage DC:** | 50 VDC |
| **Dielectric Withstanding Voltage:** | 125 VDC |
| **Temperature Range:** | -55/+125°C |
| **Temperature Coefficient:** | C0G |
| **Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC):** | 30 ppm/C, 1MegaHz 1.0Vrms |
| **Dissipation Factor:** | 0.1% 1 MHz 1.0Vrms |
| **Aging Rate:** | 0% Loss/Decade Hour |
| **Insulation Resistance:** | 100 GOhms |

| Packaging Specifications | |
|---|---|
| **Packaging:** | T&R, 180mm, Plastic Tape |
| **Packaging Quantity:** | 4000 |

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